

ACESOL® Wafer Polishing Slurry Series

➤ WP 100H & WP 40H

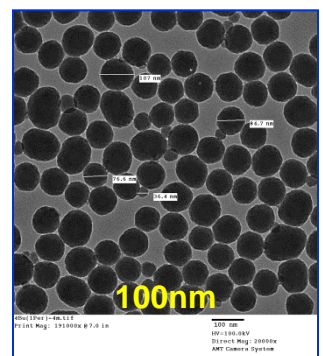
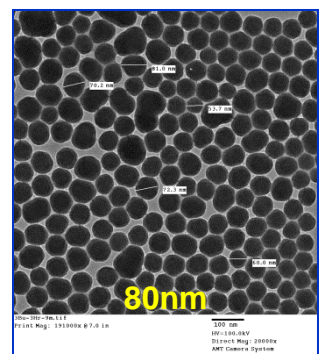
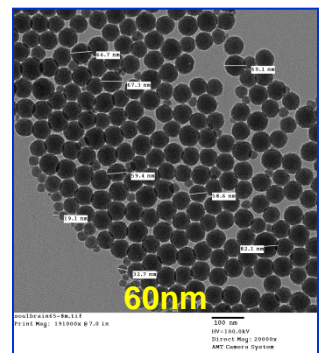
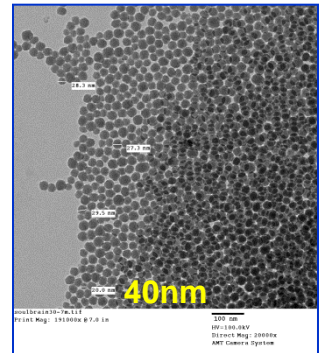
Wafer Stock polishing slurry

➤ WP 2010

Wafer Edge polishing slurry

➤ WP 3040

Wafer Back side polishing slurry



Product Summary

- Colloidal silica slurry for the polishing silicon wafers
- Various range of particle sizes designed to meet the requirements
- ACESOL® WP Series diluted as a 40x (Max) concentrated wafer CMP slurry to reduce handling and shipping costs
- Shelf life is more than 12months

Features & Benefits

- ✓ Good metal level for Cu and Ni
High purity water glass based nanoparticles
- ✓ Lower cost of ownership
Improve dilution rate for cost down
- ✓ Colloidal silica stable concentrate
Products designed to be stable across a broad pH range